



**PATENT APPLICATION**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of

Docket No: Q88153

Koji WATANABE, et al.

Appln. No.: 10/541,586

Group Art Unit: 1734

Confirmation No.: 1996

Examiner: Not yet assigned

Filed: July 7, 2005

**September 30, 2005**

For: CURING RESIN COMPOSITION, ADHESIVE EPOXY RESIN PASTE, ADHESIVE EPOXY RESIN SHEET, CONDUCTIVE CONNECTION PASTE, CONDUCTIVE CONNECTION SHEET, AND ELECTRONIC COMPONENT JOINED BODY

**INFORMATION DISCLOSURE STATEMENT**  
**UNDER 37 C.F.R. §§ 1.97 and 1.98**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In accordance with the duty of disclosure under 37 C.F.R. § 1.56, Applicant hereby notifies the U.S. Patent and Trademark Office of the documents which are listed on the attached PTO/SB/08 A & B (modified) form and/or listed herein and which the Examiner may deem material to patentability of the claims of the above-identified application.

One copy of each of the listed documents is submitted herewith, other than any U.S. patents and patent publications. Copies of the five (5) documents that were cited in the International Search Report (ISR) and identified in the Information Disclosure Statement filed on July 7, 2005 are attached, together with an English language abstract of each, for the Examiner's convenience.

INFORMATION DISCLOSURE STATEMENT  
U.S. Appln. No.: 10/541,586

The present Information Disclosure Statement is being filed before the mailing date of the first Office Action on the merits, and therefore no Statement under 37 C.F.R. § 1.97(e) or fee under 37 C.F.R. § 1.17(p) is required.

In compliance with the concise explanation requirement under 37 C.F.R. § 1.98(a)(3) and MPEP 609 for foreign language documents, Applicants note that JP 3342703 (corresponding USP 6,328,844), JP 3114162, JP 7-73066 (corresponding GB 2 280 524 and USP 5,940,603), and JP 2002-313143 are discussed on pages 3, 5, and 6 of the specification, and a corresponding English language abstract thereof is also enclosed herewith.

The submission of the listed documents is not intended as an admission that any such document constitutes prior art against the claims of the present application. Applicant does not waive any right to take any action that would be appropriate to antedate or otherwise remove any listed document as a competent reference against the claims of the present application.

The USPTO is directed and authorized to charge all required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any overpayments to said Deposit Account. A duplicate copy of this paper is attached.

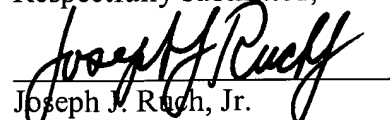
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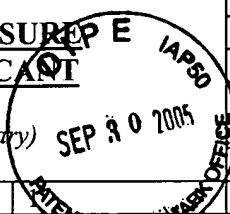
**23373**

CUSTOMER NUMBER

Respectfully submitted,

  
Joseph J. Rugh, Jr.  
Registration No. 26,577

Date: September 30, 2005

Substitute for Form 1449 A & B/PTO  <b>INFORMATION DISCLOSURE</b> <b>STATEMENT BY APPLICANT</b>  (use as many sheets as necessary)			Complete if Known	
			Application Number	10/541,586
			Confirmation Number	1996
			Filing Date	July 7, 2005
			First Named Inventor	Koji WATANABE
			Art Unit	1734
			Examiner Name	Not yet assigned
			Attorney Docket Number	Q88153
Sheet	1	of		

## U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No. <sup>1</sup>	Document Number		Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document
		Number	Kind Code <sup>2</sup> (if known)		
		US 6,328,844	B1	12-11-2001	Watanabe et al
		US 5,940,306		08-17-1999	Huang
		US			
		US			
		US			
		US			
		US			
		US			
		US			

## FOREIGN PATENT DOCUMENTS

Examiner Initials*	Cite No. <sup>1</sup>	Foreign Patent Document			Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Translation <sup>6</sup>
		Country Code <sup>3</sup>	Number <sup>4</sup>	Kind Code <sup>5</sup> (if known)			
		JP	3342703		08-23-2002	HITACHI CHEMICAL CO., LTD.	w. Abstract
		JP	3114162		09-29-2000	SONY CHEMICALS	w/ Abstract
		JP	7-73066		03-17-1995	PIE DESIGN SYSTEMS INC	w/ Abstract
		GB	2 280 524	A	02-01-1995	PIE DESIGN SYSTEMS INC	
		JP	2002-313143		10-25-2002	SEKISUI CHEMICAL CO., LTD.	w/ Abstract

## NON PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city, and/or country where published.	Translation <sup>6</sup>

Examiner Signature		Date Considered	
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\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>1</sup>Applicant's unique citation designation number (optional). <sup>2</sup>See Kind Codes of USPTO Patent Documents at www.uspto.gov, MPEP 901.04 or in the comment box of this document. <sup>3</sup>Enter Office that issued the document, by the two-letter code (WIPO Standard ST. 3). <sup>4</sup>For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup>Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup>Applicant is to indicate here if English language Translation is attached.